WHAT IS CLAIMED IS:

- 1 1.An electrostatic discharge protection circuit with high
- trigger current, coupled to a node and a reference
- 3 potential for dissipating the electrostatic voltage
- formed at said node, said electrostatic discharge
- 5 protection circuit comprising:
- a substrate having a first conductivity type, coupled to
- 7 said reference potential;
- a well region having a second conductivity type, formed on
- said substrate and coupled to said node;
- 10 a first doping region having said first conductivity type,
- electrically floated on said well region; and
- a second doping region having said second conductivity
- type, disposed on said substrate and electrically coupled
- to said reference potential;

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- wherein, the electrostatic discharge current of said node
- 16 provides a voltage with sufficient magnitude to breakdown
- the conjunction interface between said well region and said
- 18 substrate, also triggering a BIPOLAR JUNCTION
- 19 TRANSISTOR(BJT) comprising said well region, said substrate
- and said second doping region, for dissipating said
- 21 electrostatic discharge current;
- 22 and wherein said first doping area, when the electrostatic
- discharge current is greater than a predetermined current,
- reduces the potential difference between said node and said
- 25 reference potential

- 2. The electrostatic discharge protection circuit as claimed 1
- in claim 1, wherein said electrostatic discharge protection 2
- circuit further comprises a third doping area having said 3
- second conductivity type, disposed in said well region, 4
- electrically coupled to said node, for forming an ohmic 5
- connection at said well region. 6
- 3. The electrostatic discharge protection circuit as claimed 1
- in claim 1, wherein said electrostatic discharge protection 2
- circuit further comprises a forth doping region having said 3
- first conductivity type, disposed at the surface of said 4 The second of th
 - substrate near said well region, electrically coupled to
 - said reference potential, for forming an ohmic connection
 - at said substrate.
 - 4. The electrostatic discharge protection circuit as claimed
 - in claim 1, wherein said first conductivity is p-type, and
 - said second conductivity is n-type.
 - 5. The electrostatic discharge protection circuit as claimed
- _2 in claim 1, wherein said electrostatic discharge circuit
- 3 further comprises a fifth conductivity type having said
- 4 second conductivity type, disposed at the conjunction of
- said well region and said substrate, for reducing the 5
- 6 breakdown voltage at the conjunction of said well region
- 7 and said substrate.
- 6. The electrostatic discharge protection circuit as claimed 1
- 2 in claim 1, wherein said electrostatic discharge protection
- 3 circuit further comprises a field oxide layer, disposed at
- the surface of said substrate adjacent to said fifth doping 4
- 5 region.

- 1 7. The electrostatic discharge protection circuit as claimed
- in claim 1, wherein said electrostatic discharge protection
- 3 circuit further comprises a MOS resistor having a first
- 4 conductivity type disposed on said substrate and comprising
- a gate and two source/drain regions, wherein one of said
- 6 source/drain regions is electrically coupled to said well
- region, while the other of said source/drain regions,
- 8 together with said gate, is electrically coupled to said
- 9 reference potential.

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- 8. The electrostatic discharge protection circuit as claimed in claim 4, wherein one of said drain/source regions of said MOS resistor having said first conductivity type is comprised of said fifth doping region, and the other of said drain/source regions of said MOS resistor having said first conductivity type is comprised of said second doping region.
- 9. The electrostatic discharge protection circuit as claimed in claim 7, wherein one of said drain/source regions of said MOS resistor having said first conductivity type is comprised of said fifth doping region, and the other of said drain/source regions of said MOS resistor having said first conductivity type is comprised of said second doping region.
- 1 10. The electrostatic discharge protection circuit as
- 2 claimed in claim 1, wherein said electrostatic discharge
- 3 protection circuit further comprises:
- 4 a MOS resistor having said first conductivity type, formed
- on said substrate, comprising a gate, and two source/drain
- regions, wherein one source/drain region is electrically

- 7 coupled to said well region, and the other source/drain
- 8 region is electrically coupled to said reference potential;
- 9 a resistor, its two ends electrically coupled to said gate
- and said reference potential, respectively; and
- a capacitor, its two ends electrically coupled to said gate
- and said node, respectively.

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- 1 11.An electrostatic discharge protection circuit with high
- trigger current, coupled to a node and a reference
- 3 potential, for dissipating the electrostatic discharge
- current from said node, comprising:
 - a BJT, comprising an emitter, a base and a collector, wherein said emitter and said base are electrically coupled to said reference potential, said collector is comprised of a collector region with a second conductivity type and electrically coupled to said node; and
- a first doping region having a first conductivity type,
 floated in said collector region, and forms a conjunction
 interface with said collector region;
- wherein said first doping region, when said electrostatic
- discharge current is greater than a predetermined current,
- reduces the potential difference between said node and said
- 16 reference potential.
- 1 12. The electrostatic discharge protection circuit as
- claimed in claim 11, wherein said electrostatic discharge
- 3 protection circuit further comprises a MOS resistor having
- a first conductivity type, disposed on said substrate,
- 5 comprising a gate, and two source/drain regions, wherein
- one of said source/drain regions is electrically coupled to

- 7 said collector, while the other source/drain region,
- 8 together with said gate, is electrically coupled to said
- 9 reference potential.
- 1 13. The electrostatic discharge protection circuit as
- claimed in claim 11, wherein said electrostatic discharge
- protection circuit further comprises:
- a MOS resistor having said first conductivity type,
- 5 comprising a gate, and two source/drain regions, wherein,
- one source/drain regions is electrically coupled to said
- node, and the other source/drain is electrically coupled to
- said reference potential;

 said reference potential;

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- a resistor, its two ends electrically coupled to said gate and said reference potential, respectively; and
- a capacitor, its two ends electrically coupled to said gate and said node, respectively.
- 14. The electrostatic discharge protection circuit as claimed in claim 11, wherein said first conductivity is ptype, and said second conductivity is n-type.
- 1 15. The electrostatic discharge protection circuit as
- claimed in claim 1, wherein said first conductivity is n-
- type, and said second conductivity is p-type.
- 4 16. The electrostatic discharge protection circuit as
- 5 claimed in claim 10, wherein said first conductivity is n-
- type, and said second conductivity is p-type.
- 1 17. An electrostatic discharge protection circuit with high
- trigger current, electrically coupled to a node and a
- 3 reference potential for dissipating the electrostatic

- 4 voltage formed at said node, said electrostatic discharge
- 5 protection circuit comprising:
- a base having a first conductivity type, electrically
- 7 coupled to said reference potential;
- a well region having a second conductivity type, formed on
- 9 said substrate and electrically coupled to said node;
- a first doping region having said first conductivity type,
- 11 electrically floated on said well region and electrically
- 12 coupled to said node; and

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- a second doping region having said second conductivity type, electrically floated on said base;
- wherein the electrostatic discharge current of said node provides a voltage with sufficient magnitude to breakdown the conjunction interface between said well region and said base, also triggering a BJT comprising said well region, said base and said first doping region, for dissipating said electrostatic discharge current;
- and wherein said second doping area, when the electrostatic
- 22 discharge current is greater than a predetermined current,
- 23 reduces the potential difference between said node and said
- 24 reference potential
- 1 18. The electrostatic discharge protection circuit as
- 2 claimed in claim 17, wherein said electrostatic discharge
- 3 protection circuit further comprises a third doping area
- 4 having said second conductivity type, disposed in said well
- 5 region, electrically coupled to said node, for forming an
- 6 ohmic connection at said well region.

- 19. The electrostatic discharge protection circuit as 1
- 2 claimed in claim 17, wherein said electrostatic discharge
- protection circuit further comprises a forth doping region 3
- having said first conductivity type, disposed at the 4
- surface of said base near said well region, electrically 5
- coupled to said reference potential, for forming an ohmic 6
- 7 connection at said base.
- 20. The electrostatic discharge protection circuit as 1
- claimed in claim 17, wherein said electrostatic discharge 2
- 3 circuit further comprises a fifth conductivity type having
- said second conductivity type, disposed at the conjunction
- of said well region and said base, for reducing the
 - breakdown voltage at the conjunction of said well region
 - and said base.
- 21. The electrostatic discharge protection circuit as
 - claimed in claim 1, wherein said electrostatic discharge
- 3 protection circuit further comprises a field oxide layer,
- 4 disposed at the surface of said base adjacent to said fifth
- **1 1 5** doping region.
 - 22. The electrostatic discharge protection circuit as 1
 - claimed in claim 1, wherein said electrostatic discharge 2
 - protection circuit further comprises a MOS resistor having 3
 - a first conductivity type, disposed on said base, 4
 - 5 comprising a gate, and two source/drain regions, wherein,
 - one of said source/drain regions is coupled to said well 6
 - 7 region, while the other source/drain region, together with
 - 8 said gate, is coupled to said reference potential.
 - 23. The electrostatic discharge protection circuit as 1
 - claimed in claim 20, wherein, one of said drain/source 2
 - regions of said MOS resistor having said first conductivity 3

- type is comprised of said fifth doping region, and the 4
- other drain/source regions of said MOS resistor having said 5
- first conductivity type is comprised of said second doping 6
- region. 7
- 8 24. The electrostatic discharge protection circuit as
- claimed in claim 22, wherein, one of said drain/source 9
- regions of said MOS resistor having said first conductivity 10
- type is comprised of said fifth doping region, and the 11
- other drain/source regions of said MOS resistor having said 12
- first conductivity type is comprised of said second doping 13
- region. 14
- 7 1
- 1 25. The electrostatic discharge protection circuit as == == 2
 - claimed in claim 1, wherein said electrostatic discharge
 - protection circuit further comprises:
- 4 ± 5 a MOS resistor having said first conductivity type, formed
- on said base, and comprising a gate and two source/drain
- 6 regions, wherein one source/drain region is coupled to said
- 7 well region, and the other source/drain region is coupled
- **1**8 to said reference potential;
 - a resistor, its two ends coupled to said gate and said 9
- reference potential, respectively; and 10
- 11 a capacitor, its two ends coupled to said gate and said
- node, respectively. 12
- 26. The electrostatic discharge protection circuit as 1
- claimed in claim 17, wherein said electrostatic discharge 2
- circuit further comprises a sixth conductivity type having 3
- said first conductivity type, disposed at the conjunction 4
- of said well region and said base, for reducing the 5

- breakdown voltage at the conjunction of said well region 6
- and said base. 7
- 27. The electrostatic discharge protection circuit as 1
- claimed in claim 26, wherein said electrostatic discharge 2
- protection circuit further comprises a field oxide layer, ર
- disposed at the surface of said well adjacent to said sixth 4
- doping region. 5
- 28. The electrostatic discharge protection circuit as 1
- claimed in claim 27, wherein said electrostatic discharge 2
- protection circuit further comprises a MOS resistor having 3
- a second conductivity type, disposed on said well region, The state of the s
 - comprising a gate and two source/drain regions, wherein one
 - of said source/drain regions is electrically coupled to
 - said base, while the other source/drain region, together
 - with said gate, is electrically coupled to said node.
 - 29. The electrostatic discharge protection circuit as
- claimed in claim 18, wherein, one of said drain/source of ___2
 - said MOS resistor having said second conductivity type is
- comprised of said sixth doping region, and the other 4
- drain/source of said MOS resistor is comprised of said 5
- third doping region. 6
- 30. The electrostatic discharge protection circuit as 1
- claimed in claim 28, wherein, one of said drain/source of 2
- said MOS resistor having said second conductivity type is 3
- comprised of said sixth doping region, and the other 4
- drain/source of said MOS resistor is comprised of said 5
- 6 third doping region.
- 31. The electrostatic discharge protection circuit as 1
- claimed in claim 26, wherein said electrostatic discharge 2
- protection circuit further comprises: 3

- 4 a MOS resistor having said second conductivity type,
- 5 comprising a gate, and two source/drain regions, wherein,
- one source/drain region is electrically coupled to said
- 7 node, and the other source/drain region is electrically
- 8 coupled to said reference potential;
- a resistor, its two ends electrically coupled to said gate
- 10 and said node, respectively; and

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- 11 a capacitor, its two ends electrically coupled to said gate
- and said reference voltage, respectively.
 - 32. The electrostatic discharge protection circuit as claimed in claim 17, wherein said first conductivity is ptype, and said second conductivity is n-type.
 - 33. The electrostatic discharge protection circuit as claimed in claim 17, wherein said first conductivity is n-type, and said second conductivity is p-type.
 - 34. An electrostatic discharge protection circuit with high trigger current, electrically coupled to a node and a reference potential for dissipating the electrostatic
 - 4 voltage formed at said node, said electrostatic discharge
 - 5 protection circuit comprising:
 - a BJT, comprising an emitter, a base and a collector,
 - 7 wherein said emitter and said base are electrically coupled
 - 8 to said node, said collector is comprised of a collector
 - 9 region with a first conductivity type and electrically
- 10 coupled to said reference potential; and
- a second doping region having a second conductivity type,
- 12 floated in said collector region, and forms a conjunction
- interface with said collector region;

- wherein said second doping region, when said electrostatic
- discharge current is greater than a predetermined current,
- reduces the potential difference between said node and said
- 17 reference potential.

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- 35. The electrostatic discharge protection circuit as
- 2 claimed in claim 34, wherein said electrostatic discharge
- 3 protection circuit further comprises a MOS resistor having
- a first conductivity type, comprising a gate, and two
- source/drain, wherein, one of said source/drain is
- 6 electrically coupled to said collector, while the other
- 7 source/drain region, together with said gate are
- electrically coupled to said reference potential.
 - 36. The electrostatic discharge protection circuit as claimed in claim 34, wherein said electrostatic discharge protection circuit further comprises:
 - a MOS resistor having said first conductivity type, comprising a gate, and two source/drain, wherein, one source/drain is electrically coupled to said node, and the other source/drain is electrically coupled to said reference potential;
- 9 a resistor, its two ends are respectively electrically
- 10 coupled to said gate and said reference potential; and
- a capacitor, its two ends are respectively electrically
- 12 coupled to said gate and said node.
- 1 37. The electrostatic discharge protection circuit as
- 2 claimed in claim 11, wherein said first conductivity is p-
- type, and said second conductivity is n-type.